

# Thyristor Modules

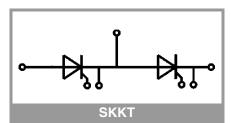
### SKKT 107/16 E

#### Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- UL recognized, file no. E63532

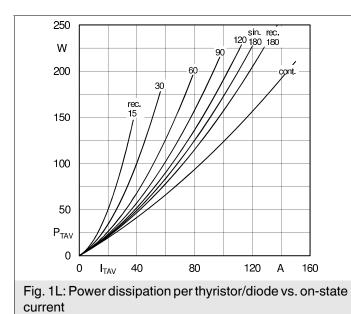
### **Typical Applications\***

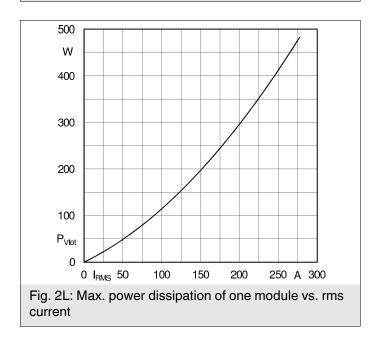
- DC motor control (e. g. for machine tools)
- AC motor soft starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

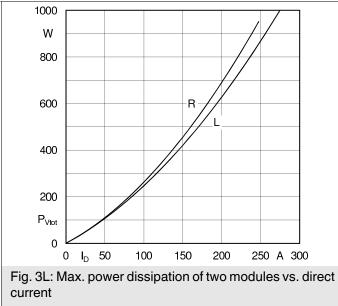


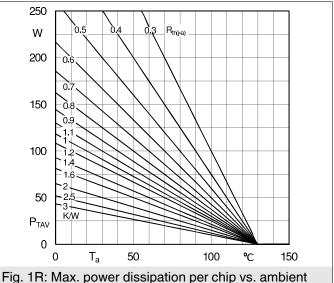
<b>.</b>				
Symbol	Conditions		Values	Unit
Chip				
I <sub>T(AV)</sub>	sinus 180°	T <sub>c</sub> = 85 °C	119	А
		T <sub>c</sub> = 100 °C	91	A
I <sub>TRMS</sub>	continuous operation		190	A
I <sub>TSM</sub>	10 ms	T <sub>j</sub> = 25 °C	2250	A
		T <sub>j</sub> = 130 °C	1900	A
i <sup>2</sup> t	10 ms	T <sub>j</sub> = 25 °C	25313	A²s
		T <sub>j</sub> = 130 °C	18050	A²s
V <sub>RSM</sub>			1700	V
V <sub>RRM</sub>			1600	V
V <sub>DRM</sub>			1600	V
(di/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C		140	A/µs
(dv/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C		1000	V/µs
Tj			-40 130	°C
Module	-			
T <sub>stg</sub>			-40 125	°C
V <sub>isol</sub>	a.c.; 50 Hz; r.m.s.	1 min	3000	V
		1 s	3600	V

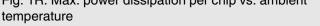
Characte	eristics					
Symbol	Conditions	min.	typ.	max.	Unit	
Chip						
V <sub>T</sub>	T <sub>j</sub> = 25 °C, I <sub>T</sub> = 300 A			1.6	1.75	V
V <sub>T(TO)</sub>	T <sub>j</sub> = 130 °C			0.8	0.9	V
r <sub>T</sub>	T <sub>j</sub> = 130 °C			2.80	3.35	mΩ
I <sub>DD</sub> ;I <sub>RD</sub>	$T_j = 130 \text{ °C}, V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$				20	mA
t <sub>gd</sub>	$T_j = 25 \ ^\circ C$ , $I_G = 1 \ A$ , $di_G/dt = 1 \ A/\mu s$			1		μs
t <sub>gr</sub>	$V_{D} = 0.67 * V_{DRM}$			2		μs
t <sub>q</sub>	T <sub>j</sub> = 130 °C			200		μs
I <sub>H</sub>	T <sub>j</sub> = 25 °C			150	250	mA
۱L	$T_j = 25 \ ^\circ C$ , $R_G = 33 \ \Omega$			300	600	mA
V <sub>GT</sub>	$T_j = 25 \ ^{\circ}C, \ d.c.$		2.5			V
I <sub>GT</sub>	$T_j = 25 \ ^{\circ}C, \ d.c.$		100			mA
$V_{GD}$	T <sub>j</sub> = 130 °C, d.c.				0.25	V
I <sub>GD</sub>	T <sub>j</sub> = 130 °C, d.c.				4	mA
R <sub>th(j-c)</sub>	continuous DC	per chip			0.19	K/W
		per module			0.095	K/W
R <sub>th(j-c)</sub>	_sin. 180°	per chip			0.2	K/W
		per module			0.1	K/W
R <sub>th(j-c)</sub>	−rec. 120°	per chip			0.21	K/W
		per module			0.105	K/W
Module						
R <sub>th(c-s)</sub>	chip			0.22		K/W
	module			0.11		K/W
Ms	to heatsink M5		4.25		5.75	Nm
Mt	to terminals M5		2.55		3.45	Nm
а					5 * 9,81	m/s²
w				75		g

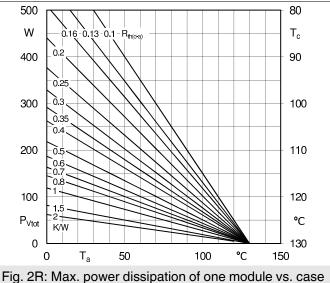


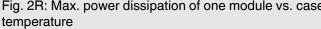


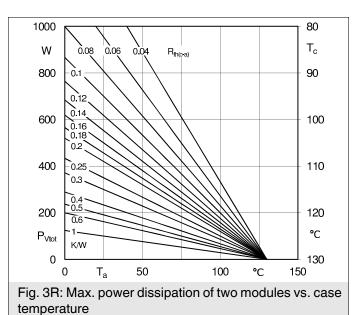




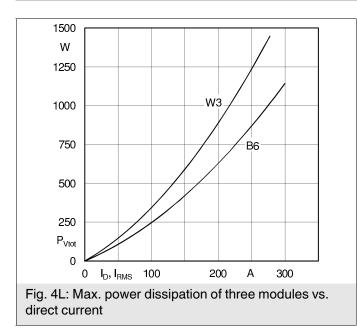


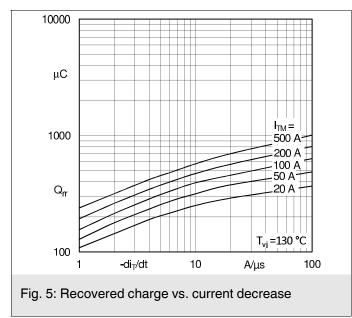


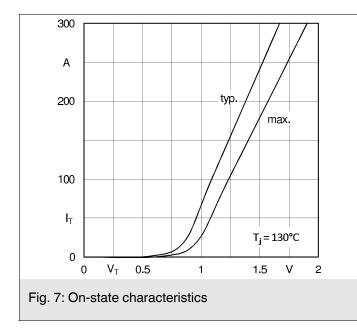




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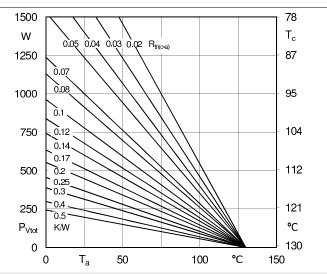
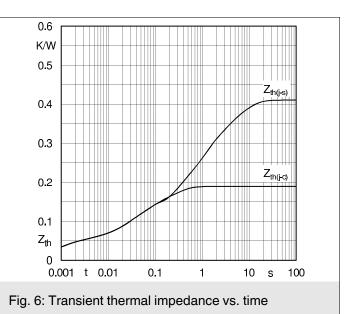
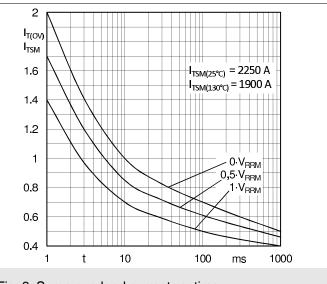
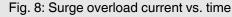


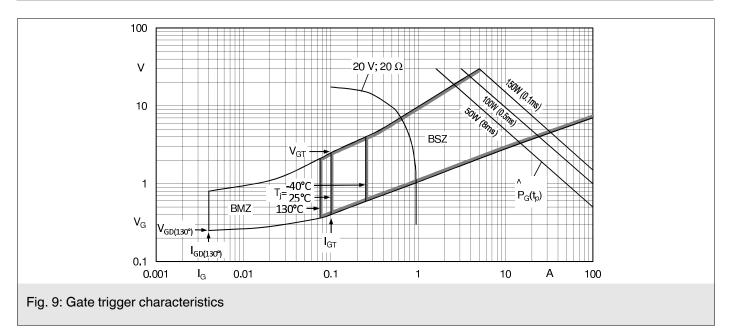
Fig. 4R: Max. power dissipation of three modules vs. case temperature

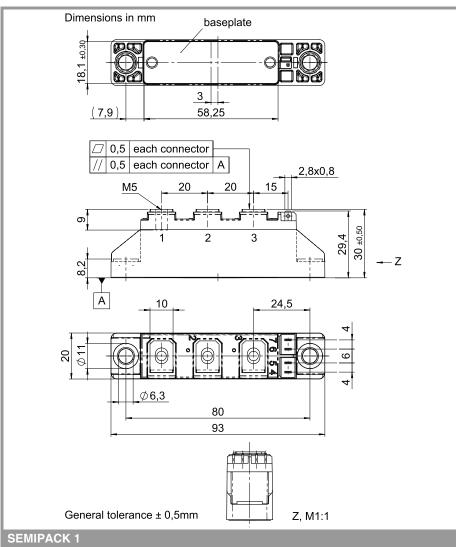


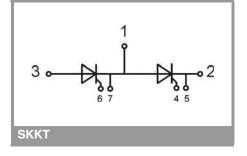




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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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